

S/N 10/789,882

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Paul A. Farrar

Examiner: Dao Nguyen

Serial No.: 10/789,882

Group Art Unit: 2818

Filed: February 27, 2004

Docket No.: 303.673US3

Customer No.: 73115

Confirmation No.: 9145

Title: INTEGRATED CIRCUIT AND SEED LAYERS

COMMUNICATION RE: FEE ADDRESS

Mail Stop Issue Fee
Commissioner for Patents
P.O.Box 1450
Alexandria, VA 22313-1450

In response to the Notice of Allowance and Issue Fee Due, please record the Fee Address under the provisions of 37 CFR 1.363 as the following:

Customer Number 26809

which is associated with Micron Technology, Inc..

Please direct any inquiries to the undersigned attorney at (612) 371-2157.

Respectfully submitted,

SCHWEGMAN, LUNDBERG & WOESSNER, P.A.
P.O. Box 2938
Minneapolis, MN 55402
(612) 371-2157

Date 27 May 2008
DRC:CMG:ker1

By David R. Cochran
David R. Cochran
Reg. No. 46,632

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is filed using the USPTO's electronic filing system EFS-Web, and is addressed to: Mail Stop Issue Fee, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on this 27 day of May, 2008.

KATHLEEN E. ROTHROCK
Name

Thulleen E. Rothrock
Signature